

# TM4616

## N+P-Channel Enhancement Mode Mosfet

### General Description

- Low  $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

### Applications

- Load switch
- PWM

### General Features

#### N Channel

$V_{DS} = 30V$   $I_D = 12A$

$R_{DS(ON)} = 9m\Omega$  (typ) @  $V_{GS} = 10V$

#### P Channel

$V_{DS} = -30V$   $I_D = -12A$

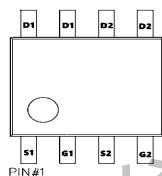
$R_{DS(ON)} = 14m\Omega$  (typ) @  $V_{GS} = -10V$

100% UIS Tested

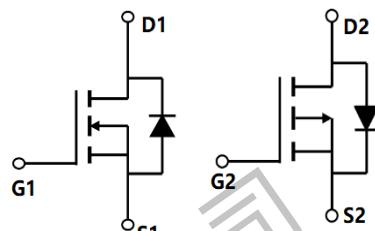
100%  $R_g$  Tested



S:SOP-8L



Marking: 4616



### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating		Units
		N-Channel	P-Channel	
$V_{DS}$	Drain-Source Voltage	30	-30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	$\pm 20$	V
$I_D$ @ $T_c=25^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V <sup>1</sup>	12	-12	A
$I_D$ @ $T_c=100^\circ C$	Continuous Drain Current, $V_{GS}$ @ 10V <sup>1</sup>	6.2	-5.6	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	35	-32	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	72	62	mJ
$I_{AS}$	Avalanche Current	21	-19	A
$P_D$ @ $T_c=25^\circ C$	Total Power Dissipation <sup>4</sup>	2.5	3.08	W
$T_{STG}$	Storage Temperature Range	-55 to 175	-55 to 175	°C
$T_J$	Operating Junction Temperature Range	-55 to 175	-55 to 175	°C

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>	---	45	°C/W
R	Thermal Resistance Junction-Case <sup>1</sup>	---	30	°C/W



**TM4616**
**N+P-Channel Enhancement Mode Mosfet**
**P-Channel Electrical Characteristics ( $T_J=25^{\circ}\text{C}$ , unless otherwise noted)**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_D = -250\mu\text{A}$	-30	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}= -30\text{V}, V_{\text{GS}}=0\text{V},$	-	-	-1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate to Body Leakage Current	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}= \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_D = -250\mu\text{A}$	-1.0	-1.5	-2.0	V
$R_{\text{DS}(\text{on})}$ note3	Static Drain-Source on-Resistance	$V_{\text{GS}}= -10\text{V}, I_D = -7\text{A}$	-	14	18	$\text{m}\Omega$
		$V_{\text{GS}}= -4.5\text{V}, I_D = -4\text{A}$	-	19	25	
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}= -15\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$	-	982	-	pF
$C_{\text{oss}}$	Output Capacitance		-	135	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	109	-	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}= -15\text{V}, I_D = -4\text{A}, V_{\text{GS}}= -10\text{V}$	-	10	-	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	2	-	nC
$Q_{\text{gd}}$	Gate-Drain("Miller") Charge		-	2.7	-	nC
<b>Switching Characteristics</b>						
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DD}}= -15\text{V}, I_D = -7\text{A}, V_{\text{GS}}= -10\text{V}, R_{\text{GEN}}=2.5\Omega$	-	11	-	ns
$t_r$	Turn-on Rise Time		-	19	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		-	45	-	ns
$t_f$	Turn-off Fall Time		-	26	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain to Source Diode Forward Current	-	-	-12	A	
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-28	A	
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_s = -7\text{A}$	-	-0.8	-1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

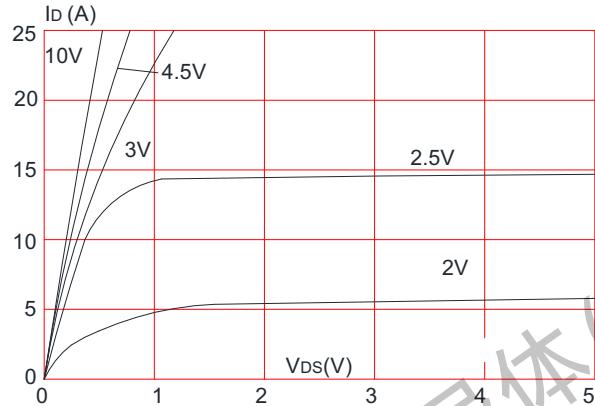
2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$

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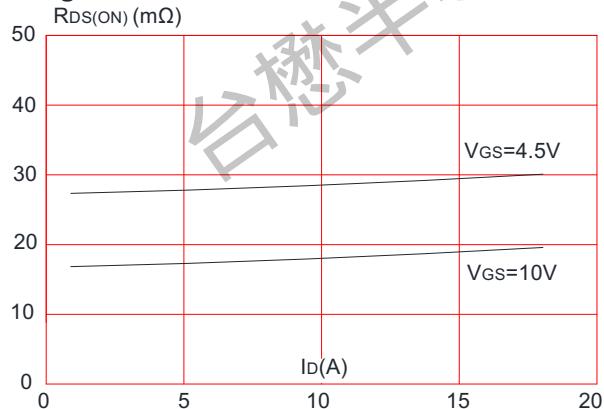
## N+P-Channel Enhancement Mode Mosfet

### N-Channel Typical Characteristics

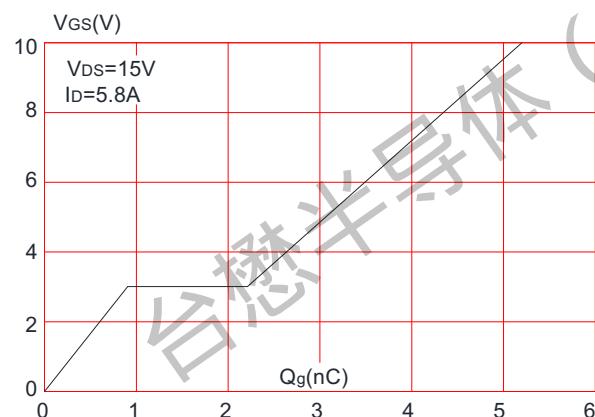
**Figure 1:** Output Characteristics



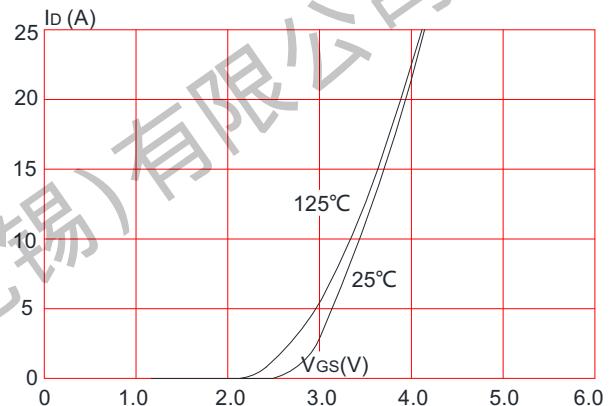
**Figure 3:** On-resistance vs. Drain Current



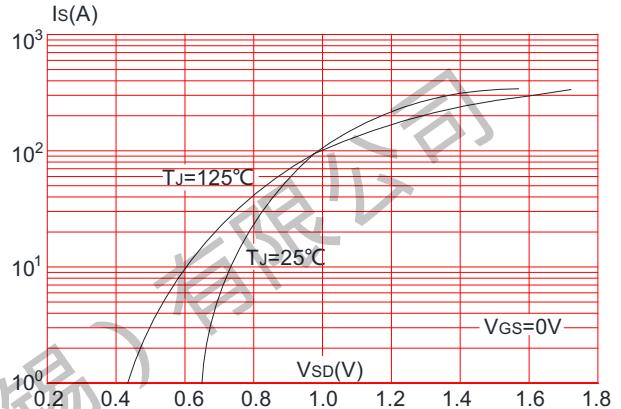
**Figure 5:** Gate Charge Characteristics



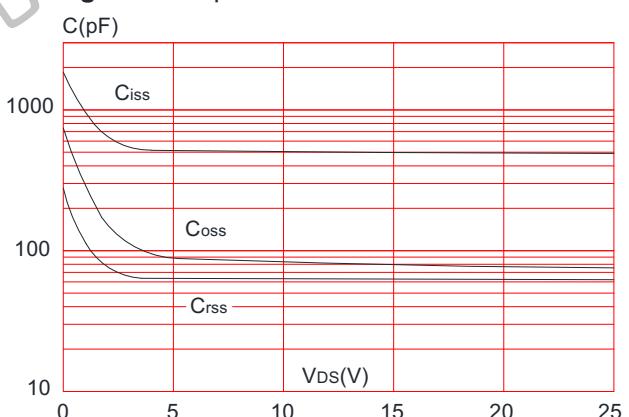
**Figure 2:** Typical Transfer Characteristics



**Figure 4:** Body Diode Characteristics



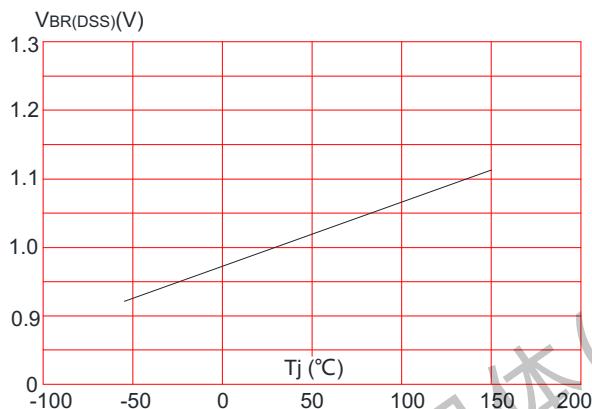
**Figure 6:** Capacitance Characteristics



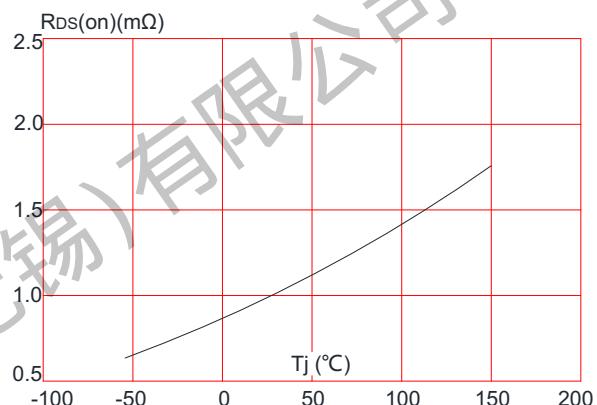
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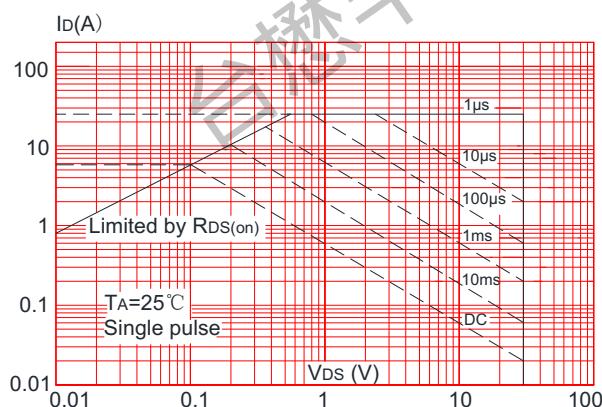
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



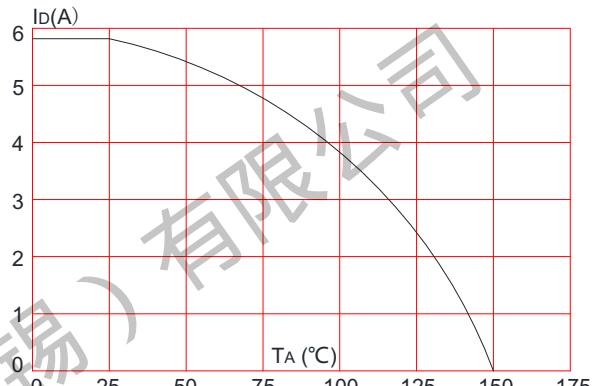
**Figure 8:** Normalized on Resistance vs. Junction Temperature



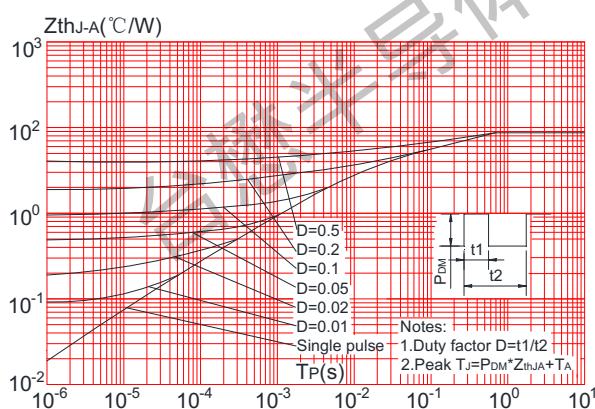
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

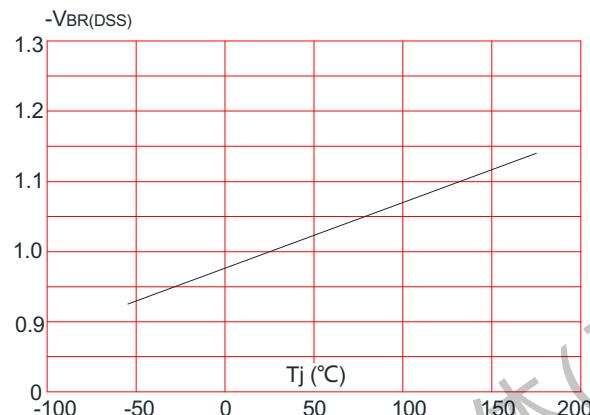




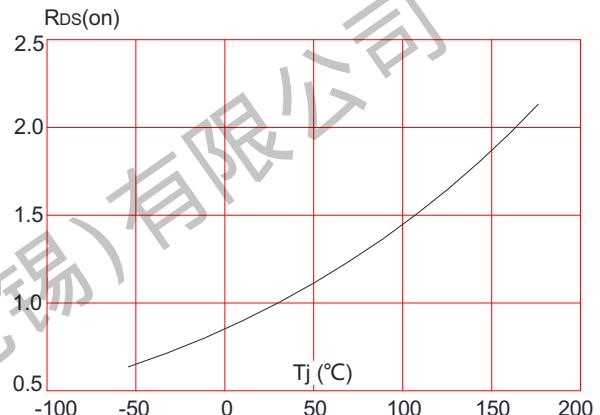
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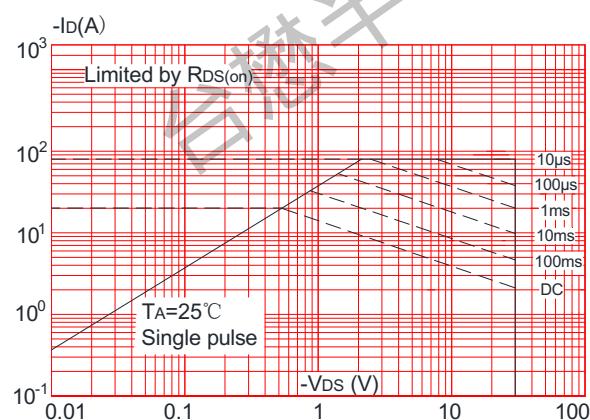
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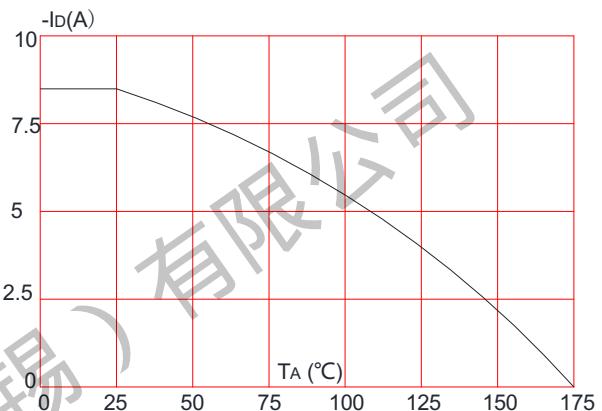
**Figure 8:** Normalized on Resistance vs. Junction Temperature



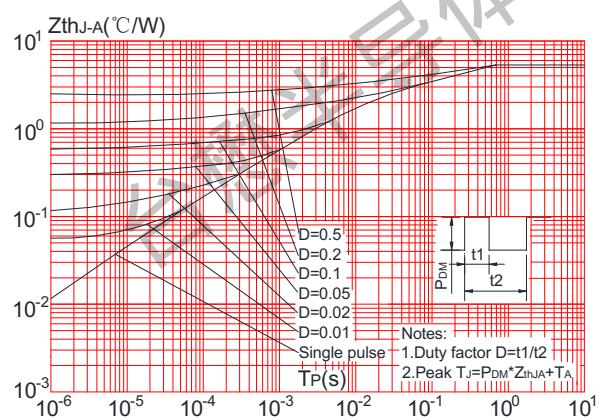
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



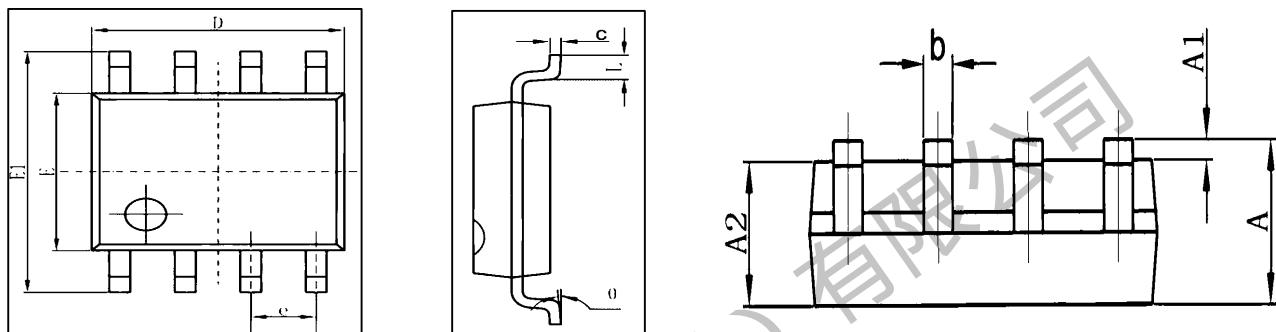
**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



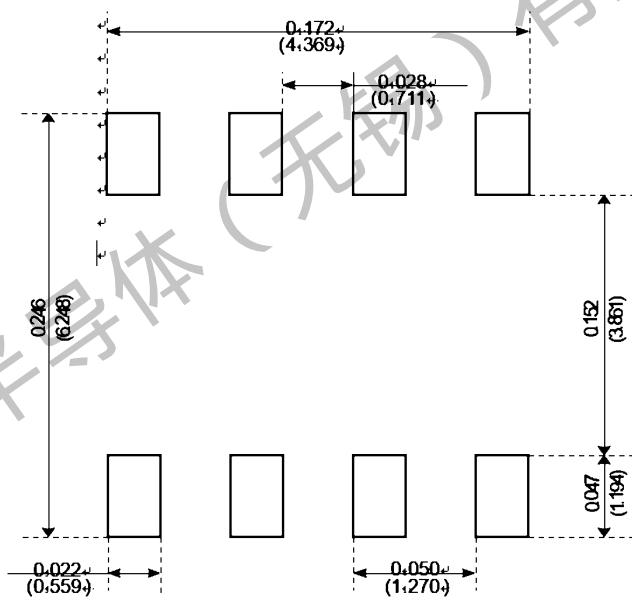
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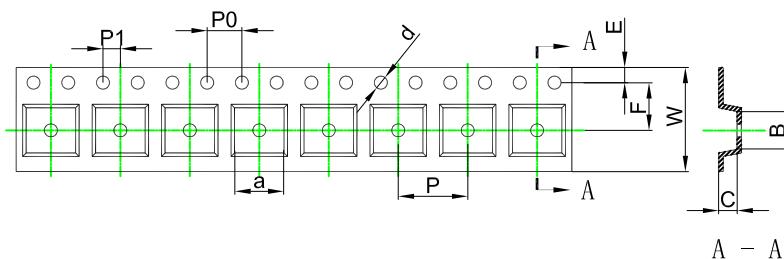
### Package Mechanical Data:SOP-8L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
$\theta$	0°	8°	0°	8°

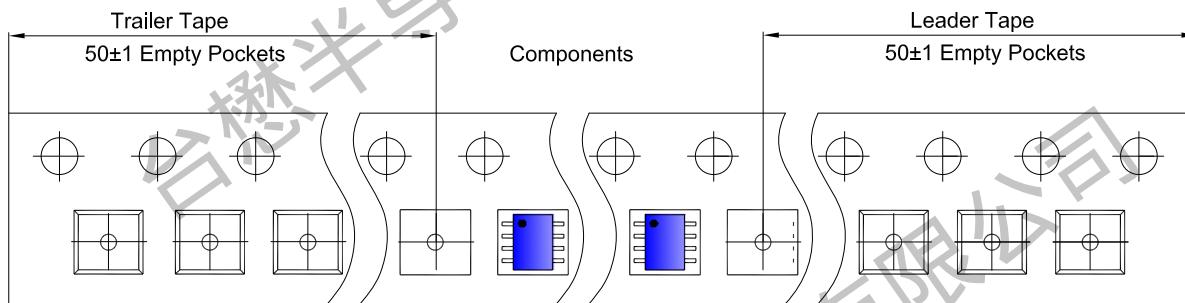
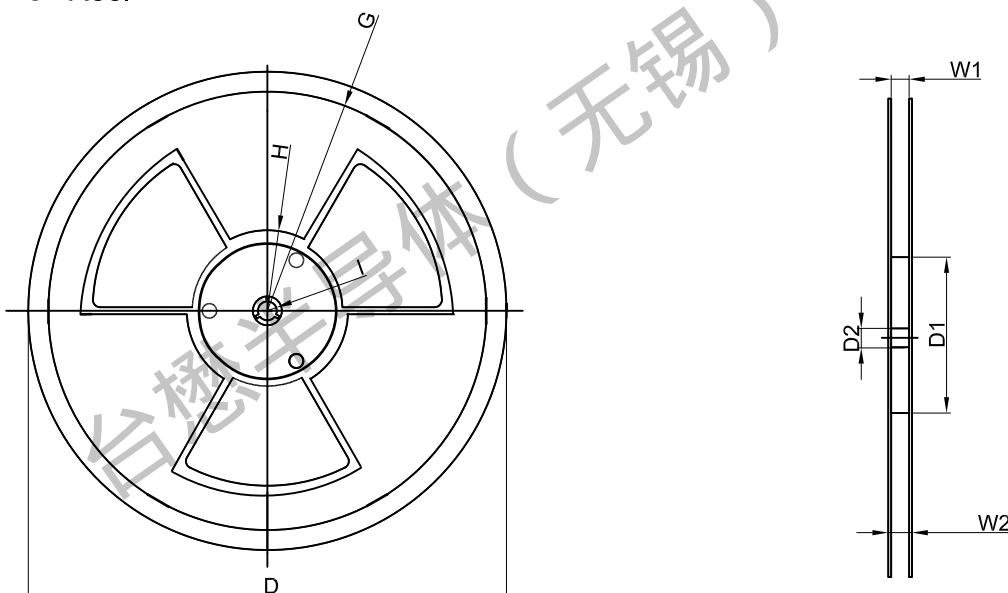


Recommended Minimum Pads

**TM4616**
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**SOP-8L Embossed Carrier Tape**

**Packaging Description:**

SOP-8L parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 2,500 units per 13" or 33cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).  
 ALL DIM IN mm

Dimensions are in millimeter										
Pkg type	a	B	C	d	E	F	P0	P	P1	W
SOP-8L	6.40	5.40	2.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

**SOP-8L Tape Leader and Trailer**

**SOP-8L Reel**


Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
13"Dia	Ø330.00	100.00	13.00	R135.00	R55.00	R6.50	12.00	14.00

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
3,000 pcs	13 inch	6,000 pcs	370×355×52	48,000 pcs	400×360×368	

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#### Revision history:

Date	Rev	Description	Page
2023.05.14	23.05	Original	